

# USB Switch ICs SPST Type (Single Pole Single Throw)



#### Description

**BH6260MWX** 

BH6260MWX is SPST x 2ch and Inverter x 2ch analog switches. Analog SW0 and SW1 pass USB 2.0 high-speed signal. Analog SW2 and SW3 pass UART signal. Moreover, this is guaranteed from 2.9V to 3.7V as for the range of the power-supply voltage. Enable signals ENB0, ENB1, EN2, and EN3 can control Analog SW0, SW1, SW2, and SW3. Furthermore, this is able to pass USB 2.0 high-speed signal without distortion, because of Analog SW0 and SW1 are low capacitance. The electrostatic discharge protection circuit is built-in in all terminals.

#### Features

- 1)  $5\Omega$  switches connect inputs to outputs
- 2) Low Capacity Analog SW 2ch with clamp Diode
- 3) 1.8V Output Inverter 2ch
- 4) 16-Pin SON Package (3.3mm x 1.5mm, Height=0.6mm, 0.4mm pitch)
- 5) It contributes to the miniaturization because all external is built into.

#### Applications

Digital Still Cameras, Digital Video Camcorders, Portable Navigation Devices, TV, Portable DVD Players, Portable Game Systems, Personal computers, PDA, Mobile phones

#### Line up matrix

Parameter	BH6260MWX	BD11600NUX	BD11603MWX	BD11601NUX
Supply Quiescent Current	0 μΑ	18 μA	18 μA	18 μA
Input voltage range	2.9~3.7 V	2.5~5.5 V	2.5~5.5 V	2.5~5.5 V
Switch ON Resistance ( VIN=0 V )	5 Ω	3Ω	3Ω	2.5 Ω
Switch ON Capacitance	10 pF	6 pF	7 pF	6 pF
Configuration	SPST x 2ch and Inverter x 2ch	DPDT	MUX x 2Lines	DPST
Package	USON016X3315	VSON010X3020	USON016X3315	VSON008X2020

#### Absolute maximum ratings (Ta=25°C)

Parameter	Symbol	Ratings	Unit	Conditions
Input supply voltage1	Vmax1	-0.3~5.5	V	VDD,VDD18,B2,ENB0 ENB1,EN2,EN3
Input supply voltage2	Vmax2	-0.3~VDD+0.3	V	A0,B0,A1,B1,A3
Input supply voltage3	Vmax3	-0.3~VDD18+0.3	V	В3
Input supply voltage4	Vmax4	-0.3~VDD+0.3	V	A2 *3
Input supply voltage5	Vmax5	-0.3~VDD18+0.3	V	A2 *4
Power dissipation	Pd	850	mW	*1
Operating temperature range	Topr	-40~+85	°C	
Storage temperature range	Tstr	-55~+125	°C	

\*1 When using more than at Ta=25°C, it is reduced 8.5 mW per 1°C. ROHM specification board 70mm × 70mm mounting.

# ●Operating conditions (Ta=-40~+85°C)

Parameter	Symbol	Ratings	Unit	Conditions
Input voltage range (VDD)	VDD	2.9~3.7	V	
Input voltage range (VDD18)	VDD18	1.7~3.6	V	

\* This product does not especially designed to be protected from radioactivity

#### • Electrical characteristics (Unless otherwise noted, Ta = 25°C, VDD=3.3V, VDD18=1.8V)

	December 20 0, VDD 0, V				O and d'it's a set	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
●Total						
Supply Quiescent Current 1	ICC1	-	0	10	μA	VDD=3.3V, ENB0/1:L, EN2/3:H
Supply Quiescent Current 2	ICC2	-	0	10	μA	VDD=3.3V, ENB0/1:H, EN2/3:L
Switch ON Resistance 1	Ron1	-	5	10	Ω	VIN=0V
Switch ON Resistance 2	Ron2	-	8	13	Ω	VIN=2.4V
Switch OFF Capacitance (A2, A3)	Coff	-	5.0	-	pF	f=1MHz
Switch ON Capacitance (A0, A1)	Con	-	10	-	pF	f=1MHz
INV2 Input "L" level	VILBUF2	-	-	0.25 × VDD18	V	
INV2 Input "H" level	VIHBUF2	0.75× VDD18	-	-	V	
INV2 Output "L" level	VOLBUF2	-	0.15	0.3	V	lo=3mA
INV2 Output "H" level	VOHBUF2	1.50	1.65	-	V	lo=-3mA
INV3 Input "L" level	VILBUF3	-	-	0.25 × VDD18	V	
INV3 Input "H" level	VIHBUF3	0.75× VDD18	-	-	V	
INV3 Output "L" level	VOLBUF3	-	0.15	0.3	V	lo=3mA
INV3 Output "H" level	VOHBUF3	1.50	1.65	-	V	lo=-3mA
ENBn/ENn input "H" level	VIHENB	0.75× VDD	-	-	V	
ENBn/ENn input "L" level	VILENB	-	-	0.25 × VDD	V	
INV3 Input Resister	RININV3	50	100	150	kΩ	EN3:H
Clamp Diode Voltage1	VIK1	-1.2	-0.73	-	V	
Clamp Diode Voltage2	VIK2	-	0.73	1.2	V	A0,B0,A1,B1,A2,A3
Propagation Delay (*1)	tPLH, tPHL	-	-	0.25	ns	CL=50pF,RL=500 Ω
BUS Enable Time (*1)	tPZH, tPZL	-	-	200	ns	CL=50pF,RL=500 Ω
BUS Disable Time (*1)	tPHZ, tPLZ	-	-	200	ns	CL=50pF,RL=500 Ω

# • Electrical characteristic curves (Reference data)

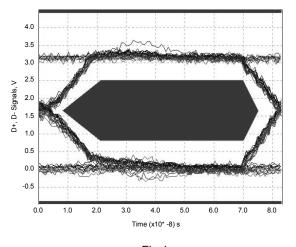


Fig.1 Eye Pattern Full Speed

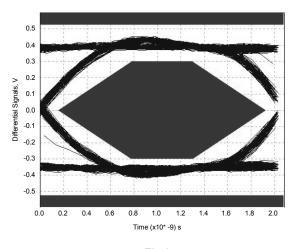
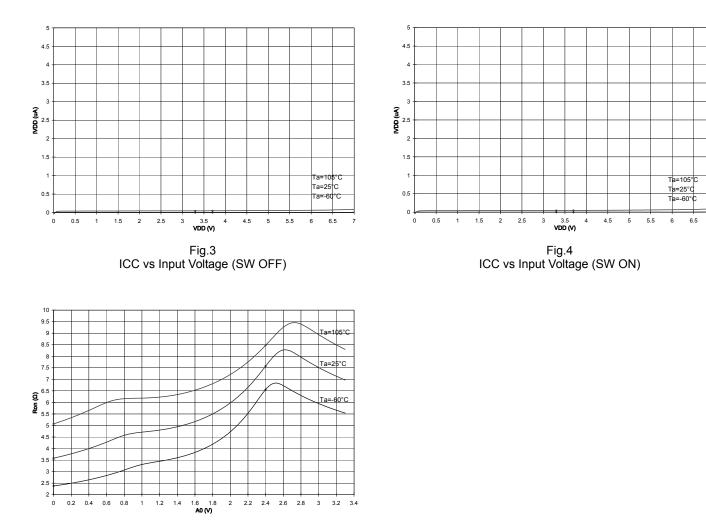
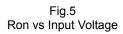


Fig.2 Eye Pattern High Speed





# Block diagram and pin configuration

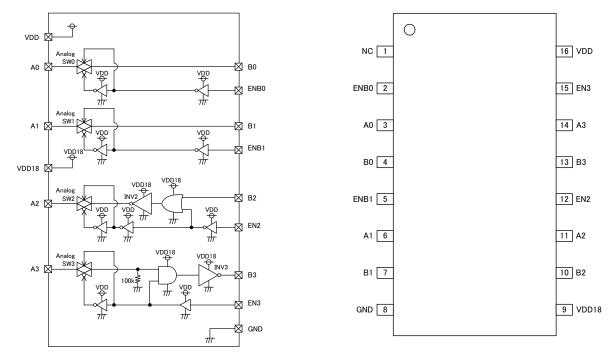
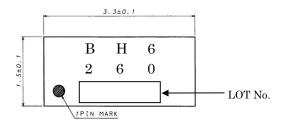
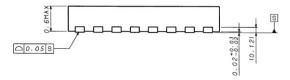


Fig.6 Block diagram

Fig.7 Pin configuration







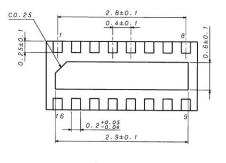


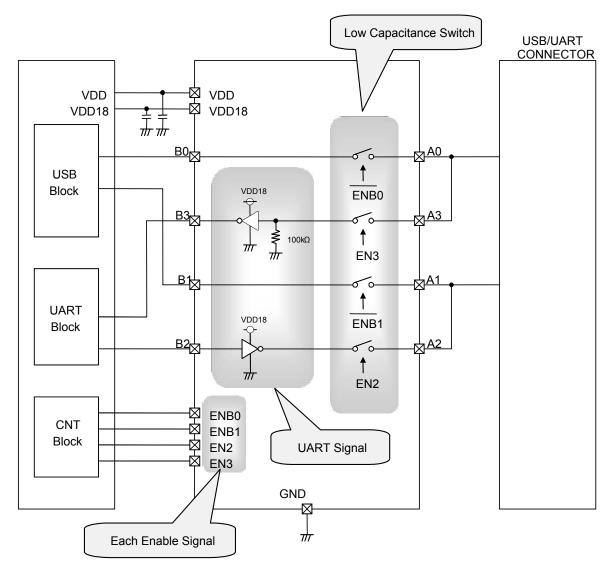
Fig.8 Package Dimensions

(UNIT:mm)

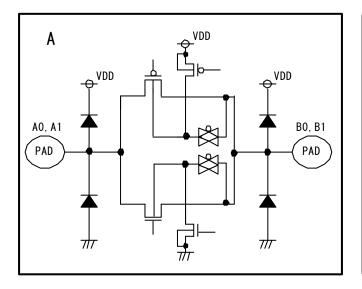
## Pin Description

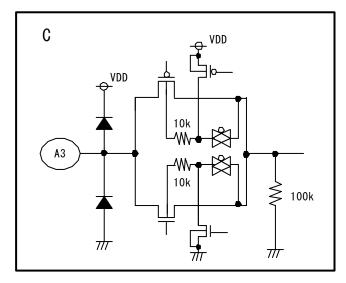
Pin NO.	Terminal circuit	Pin Name	I/O	Function
16	-	VDD	-	Power supply.
9	-	VDD18	-	Power supply for INV2,3
8	-	GND	-	Ground Pin
3,6 4,7	А	A 0~1 B 0~1	I/O	Analog SW0,1 terminal
11	В	A2	0	INV2 Output
14	С	A3	I	INV3 Input
10	D	B2	I	INV2 Input
13	E	B3	0	INV3 Output
2,5	F	ENB 0-1	I	Analog SW0-1 ON/OFF Pin. (ENBn is Low : Analog SW is ON.)
12,15	F	EN 2-3	I	Analog SW2-3 ON/OFF Pin. (ENn is High : Analog SW is ON.)

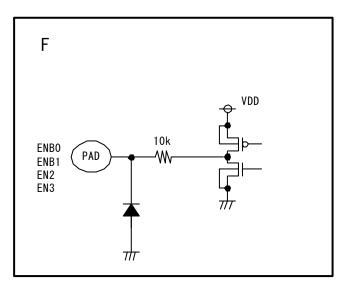
### Application Circuit

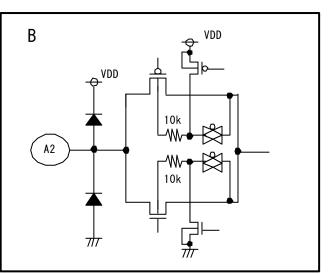


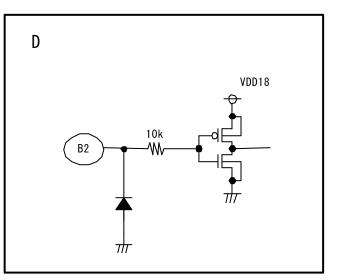
# ●Equivalent Circuit

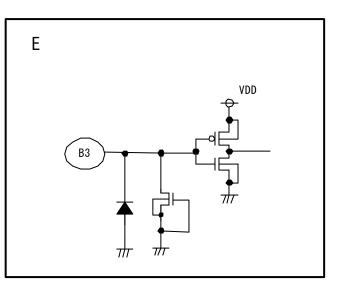












#### Notes for use

(1) Absolute maximum ratings

If applied voltage (VCČ1, VCC2), operating temperature range (Topr), or other absolute maximum ratings are exceeded, there is a risk of damage. Since it is not possible to identify short, open, or other damage modes, if special modes in which absolute maximum ratings are exceeded are assumed, consider applying fuses or other physical safety measures.

(2) Recommended operating range

This is the range within which it is possible to obtain roughly the expected characteristics. For electrical characteristics, it is those that are guaranteed under the conditions for each parameter. Even when these are within the recommended operating range, voltage and temperature characteristics are indicated.

#### (3) Reverse connection of power supply connector

There is a risk of damaging the LSI by reverse connection of the power supply connector. For protection from reverse connection, take measures such as externally placing a diode between the power supply and the power supply pin of the LSI.

(4) Power supply lines

In the design of the board pattern, make power supply and GND line wiring low impedance. When doing so, although the digital power supply and analog power supply are the same potential, separate the digital power supply pattern and analog power supply pattern to deter digital noise from entering the analog power supply due to the common impedance of the wiring patterns. Similarly take pattern design into account for GND lines as well. Furthermore, for all power supply pins of the LSI, in conjunction with inserting capacitors between power supply and GND pins, when using electrolytic capacitors, determine constants upon adequately confirming that capacitance loss occurring at low temperatures is not a problem for various characteristics of the capacitors used.

(5) GND voltage

Make the potential of a GND pin such that it will be the lowest potential even if operating below that. In addition, confirm that there are no pins for which the potential becomes less than a GND by actually including transition phenomena.

(6) Shorts between pins and misinstallation

When installing in the set board, pay adequate attention to orientation and placement discrepancies of the LSI. If it is installed erroneously, there is a risk of LSI damage. There also is a risk of damage if it is shorted by a foreign substance getting between pins or between a pin and a power supply or GND.

- (7) Operation in strong magnetic fields Be careful when using the LSI in a strong magnetic field, since it may malfunction.
- (8) Inspection in set board

When inspecting the LSI in the set board, since there is a risk of stress to the LSI when capacitors are connected to low impedance LSI pins, be sure to discharge for each process. Moreover, when getting it on and off of a jig in the inspection process, always connect it after turning off the power supply, perform the inspection, and remove it after turning off the power supply. Furthermore, as countermeasures against static electricity, use grounding in the assembly process and take appropriate care in transport and storage.

(9) Input pins

Parasitic elements inevitably are formed on an LSI structure due to potential relationships. Because parasitic elements operate, they give rise to interference with circuit operation and may be the cause of malfunctions as well as damage. Accordingly, take care not to apply a lower voltage than GND to an input pin or use the LSI in other ways such that parasitic elements operate. Moreover, do not apply a voltage to an input pin when the power supply voltage is not being applied to the LSI. Furthermore, when the power supply voltage is being applied, make each input pin a voltage less than the power supply voltage as well as within the guaranteed values of electrical characteristics.

(10) Ground wiring pattern

When there is a small signal GND and a large current GND, it is recommended that you separate the large current GND pattern and small signal GND pattern and provide single point grounding at the reference point of the set so that voltage variation due to resistance components of the pattern wiring and large currents do not cause the small signal GND voltage to change. Take care that the GND wiring pattern of externally attached components also does not change.

(11) Externally attached capacitors

When using ceramic capacitors for externally attached capacitors, determine constants upon taking into account a lowering of the rated capacitance due to DC bias and capacitance change due to factors such as temperature.

#### (12) Thermal design

Perform thermal design in which there are adequate margins by taking into account the permissible dissipation (Pd) in actual states of use.

# Power Dissipation

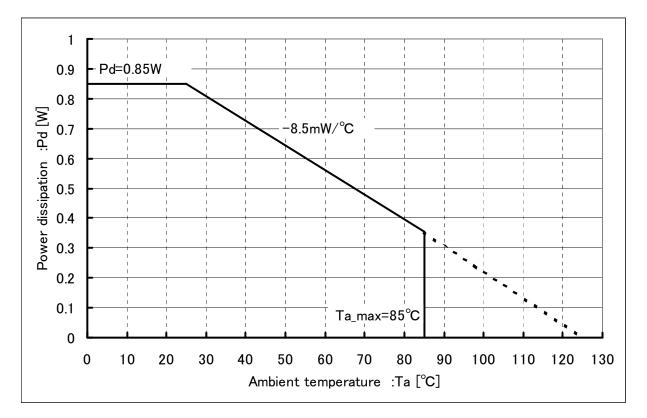
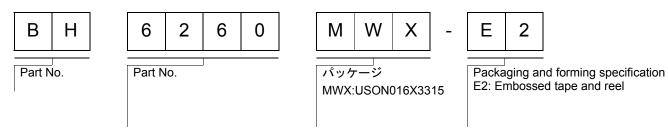
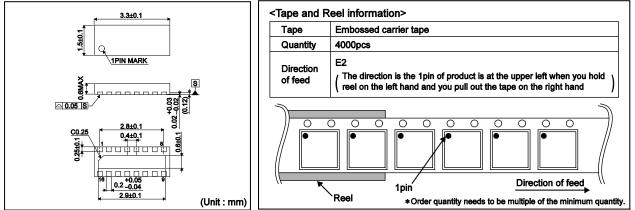


Fig.10 Power dissipation

### Ordering part number



# USON016X3315



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